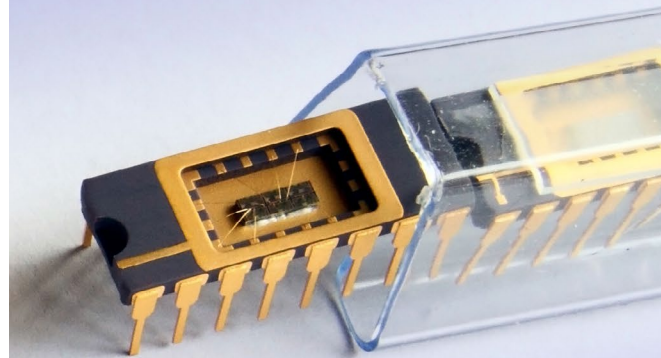


Open Cavity Plastic Packages

QP Technologies' Open Cavity Plastic Packages enable faster design verification and quicker time to market for your new devices. A proprietary process is used to turn any plastic package – whether dummies, electrical test rejects or excess inventory – into a platform for new prototypes. The QP Technologies process creates an open cavity and exposes the paddle and pads for easy assembly.



Advantages:

- IC prototypes in any plastic package
- Mechanically and electrically identical to production parts
- Unlimited package configurations
- Turnaround in 24 hours or less
- Ideal for rapid prototype assembly, design verification and customer samples
- No tooling charges
- No minimum orders

Production-Quality Packages

QP Technologies' Open Cavity Plastic Packages are mechanically and electronically identical to your future production parts. You can insert these prototype packages directly into test sockets and boards, thereby eliminating the risks associated with using nonequivalent packages.

Flexibility

The possibilities are endless, as QP Technologies can open any plastic package. You can provide the packages or we can procure them to meet your specifications. All of the most popular package configurations are available in any size or lead count.

Speed

When you need to meet a project or customer deadline, you can count on QP Technologies's reliable on-time delivery options, including same-day expedited service.

Make QP Technologies a standard part of your product development and verification process. Our Open Cavity Plastic Packages are the best solution for your prototypes, offering production-quality packages, flexibility and speed to meet your needs.

When you need a turkey solution, QP Technologies can do it all – from dicing, package procurement and preparation to die attach, wire bonding, encapsulation, remolding and marking. QP Technologies meets your deadline and delivers production-quality prototype parts for internal testing or customer samples.

